SE10FD, SE10FG, SE10FJ

Vishay General Semiconductor

AUTOMOTIVE GRADE

COMPLIANT

HALOGEN FREE

Surface-Mount Standard Rectifiers

eSMP® Series



SMF (DO-219AB)

3WII (DO-219AD)

Bottom view

Cathode O Anode

LINKS TO ADDITIONAL RESOURCES

Top view



PRIMARY CHARACTERISTICS					
I _{F(AV)}	1.0 A				
V _{RRM}	200 V, 400 V, 600 V				
I _{FSM}	25 A				
V_F at $I_F = 1.0$ A $(T_A = 125 ^{\circ}C)$	0.85 V				
I _R	5 μΑ				
T _J max.	175 °C				
Package	SMF (DO-219AB)				
Circuit configuration	Single				

FEATURES

- Low profile package
- Ideal for automated placement
- Oxide planar chip junction
- · Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- · Wave and reflow solderable
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Compatible to SOD-123W package case outline
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - for halogen-free, RoHS-compliant

Base P/NHM3 - for halogen-free, RoHS-compliant, and AEC-Q101 qualified

ALO-Q TOT qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	SE10FD	SE10FG	SE10FJ	UNIT	
Device marking code		AD	AG	AJ		
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	V	
Maximum DC forward current	I _{F(AV)} (1)	1.0			Α	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	25			А	
Operating junction and storage temperature range	Ti, Teta	-55 to +175			°C	

Notes

⁽¹⁾ Free air, mounted on recommended PCB, 2 oz. pad area

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
	I _F = 0.5 A	T _A = 25 °C		0.90	-	V
Instantaneous forward voltage	I _F = 1.0 A		V _E (1)	0.95	1.05	
Instantaneous forward voltage	I _F = 0.5 A	- T _A = 125 °C	V F ('')	0.78	-	
	I _F = 1.0 A			0.85	0.95	
Reverse current	Rated V _R	T _A = 25 °C	- I _R ⁽²⁾	-	5	μА
	Hated V _R	T _A = 125 °C		6.8	50	
Typical reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	780	-	ns
Typical junction capacitance	4.0 V, 1 MHz		CJ	7.5	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted)						
PARAMETER	SYMBOL	MBOL SE10FD SE10FG SE10FJ UNI				
Typical thermal resistance	R _{0JA} (1)	130		°C/W		
Typical thermal resistance	R _{0JM} (1)	20			G/VV	

Notes

⁽¹⁾ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient; $R_{\theta JM}$ - junction to mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS (T _A = 25 $^{\circ}$ C unless otherwise noted)						
STANDARD TEST TYPE TEST CONDITIONS SYMBOL CLASS VAI					VALUE	
AEC-Q101-001	Human body model (contact mode)	$C = 100 \text{ pF}, R = 1.5 \text{ k}\Omega$	V_{C}	НЗВ	> 8 kV	

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
SE10FJ-M3/H	0.015	Н	3000	7" diameter plastic tape and reel		
SE10FJ-M3/I	0.015	I	10 000	13" diameter plastic tape and reel		
SE10FJHM3/H (1)	0.015	Н	3000	7" diameter plastic tape and reel		
SE10FJHM3/I (1)	0.015	I	10 000	13" diameter plastic tape and reel		

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

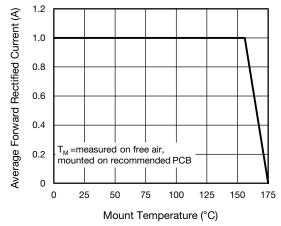


Fig. 1 - Maximum Forward Current Derating Curve

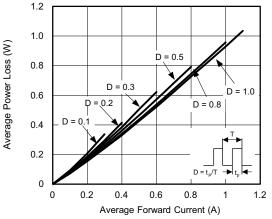


Fig. 2 - Average Power Loss Characteristics

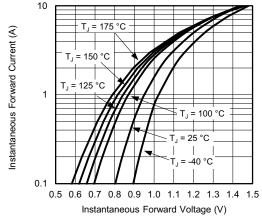


Fig. 3 - Typical Instantaneous Forward Characteristics

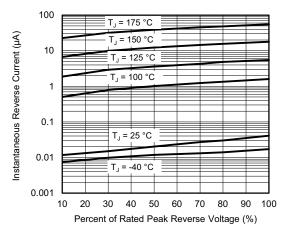


Fig. 4 - Typical Reverse Leakage Characteristics

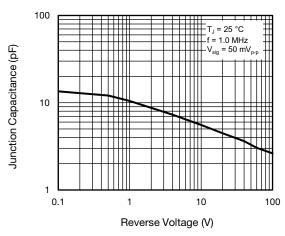


Fig. 5 - Typical Junction Capacitance

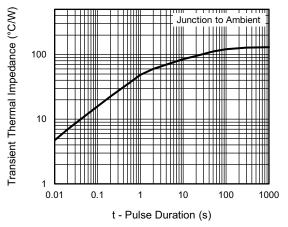
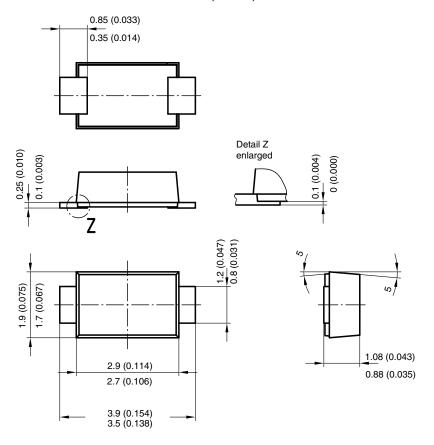


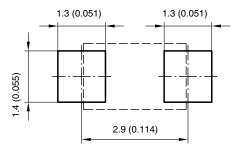
Fig. 6 - Typical Transient Thermal Impedance

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PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



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